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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HSING-FENG TSAI	07/02/2019
YEN-YUN CHANG	07/02/2019
TSUNG-TA WU	07/02/2019

RECEIVING PARTY DATA

Name:	GIGA-BYTE TECHNOLOGY CO.,LTD.
Street Address:	NO.6, BAO CHIANG ROAD, HSIN-TIEN DIST.,
City:	NEW TAIPEI CITY
State/Country:	TAIWAN
Postal Code:	231

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16538836

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	82685-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	08/14/2019

Total Attachments: 2

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> **PATENT** REEL: 050057 FRAME: 0514 505622537

ASSIGNMENT

WHEREAS,

1.Hsing-Feng Tsai 3.Tsung-Ta Wu

2.Yen-Yun Chang

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: CLAMPING MODULE AND CLAMPING SYSTEM

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, 1. GIGA-BYTE TECHNOLOGY CO.,LTD.

of No.6, Bao Chiang Road, Hsin-Tien Dist., New Taipei City 231, Taiwan

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assigner further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Hsing-Feng Tsai	Date:
Sole or First Joint Inventor: Hsing-Feng Tsai	
Signature: Yen Yun Chang Second Joint Inventor (if any): Yen-Yun Chang	Date: ついり、のり、ロン・
Signature: Tsurg-7a Wu	Date:_ <i></i>
Third Joint Inventor (if any): Tsung-Ta Wu	